

TC74HC165AP, TC74HC165AF, TC74HC165AFN

8 – BIT SHIFT REGISTER (P – IN, S – OUT)

(Note) The JEDEC SOP (FN) is not available in Japan.

The TC74HC165A is a high speed CMOS 8-BIT PARALLEL/SERIAL-IN, SERIAL-OUT SHIFT REGISTER fabricated with silicon gate C²MOS technology.

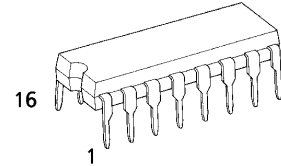
It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation. It consists of parallel-in or serial-in, serial-out 8-bit shift register with a gated clock inputs. When the $\overline{\text{SHIFT/LOAD}}$ input is held high, the serial data input is enabled and the eight flip-flops perform serial shifting with each clock pulse. When the $\overline{\text{SHIFT/LOAD}}$ input is held low, the parallel data is loaded asynchronously into the register at positive going transition of the clock pulse.

The CK-INH input should be shifted high only when the CK input is held high.

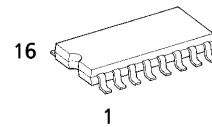
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

FEATURES :

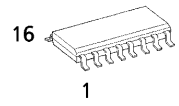
- High Speed..... $f_{\text{MAX}} = 56\text{MHz}(\text{typ.})$ at $V_{\text{CC}} = 5\text{V}$
- Low Power Dissipation..... $I_{\text{CC}} = 4\mu\text{A}(\text{Max.})$ at $T_a = 25^\circ\text{C}$
- High Noise Immunity..... $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$ (Min.)
- Output Drive Capability..... 10 LSTTL Loads
- Symmetrical Output Impedance... $|I_{\text{OH}}| = I_{\text{OL}} = 4\text{mA}(\text{Min.})$
- Balanced Propagation Delays... $t_{\text{pLH}} \approx t_{\text{pHL}}$
- Wide Operating Voltage Range... $V_{\text{CC}}(\text{opr.}) = 2\text{V} \sim 6\text{V}$
- Pin and Function Compatible with 74LS165



P (DIP16-P-300-2.54A)
Weight : 1.00g (Typ.)

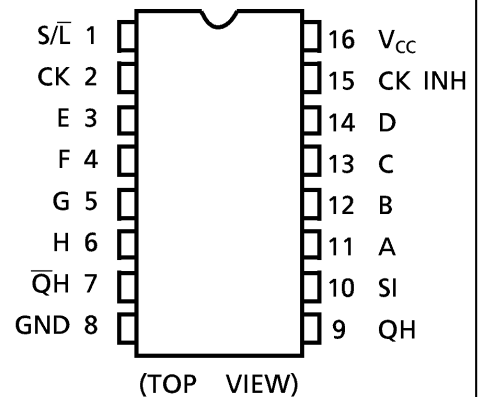


F (SOP16-P-300-1.27)
Weight : 0.18g (Typ.)

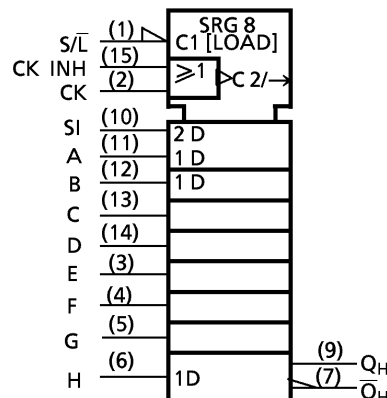


FN (SOL16-P-150-1.27)
Weight : 0.13g (Typ.)

PIN ASSIGNMENT



IEC LOGIC SYMBOL

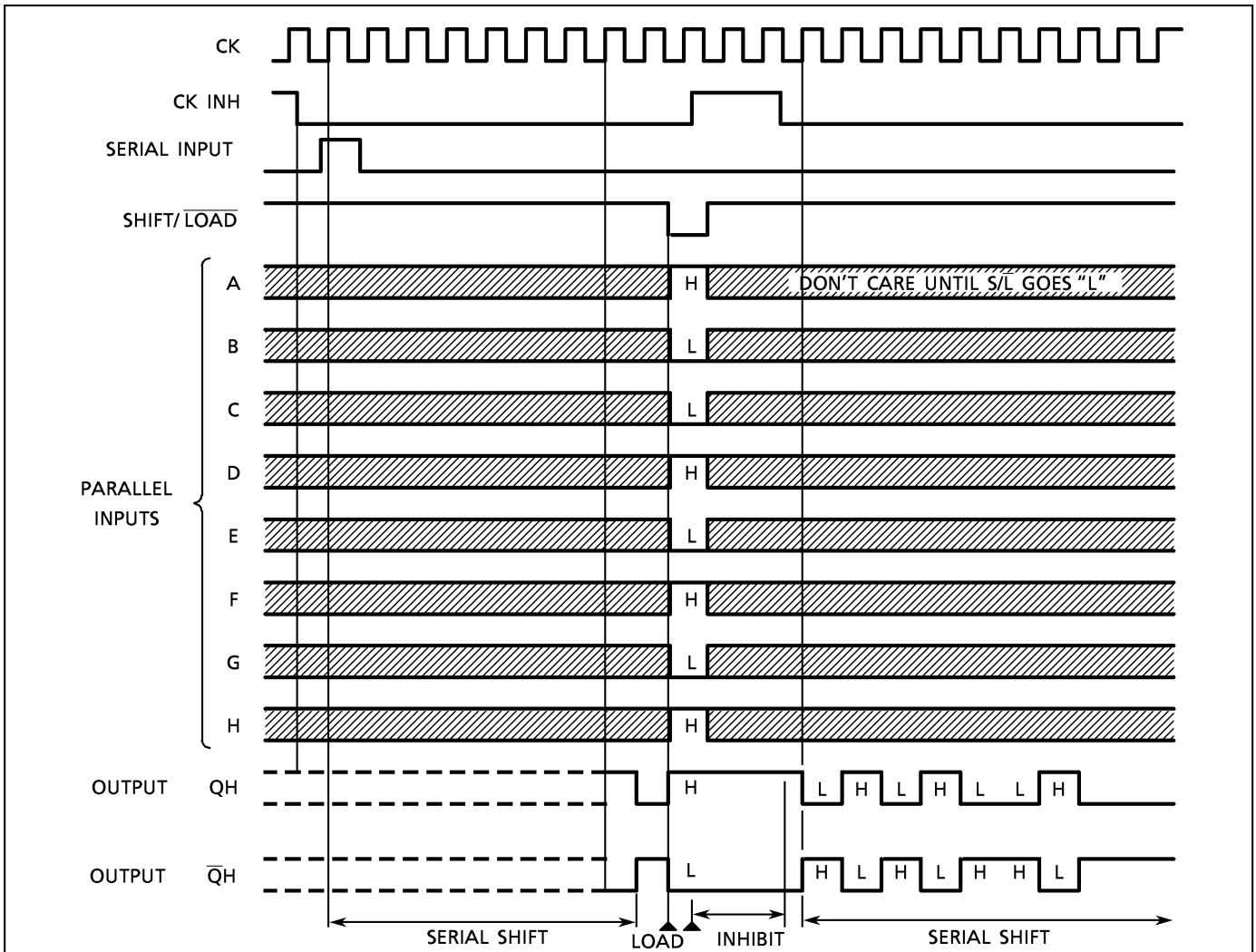


TRUTH TABLE

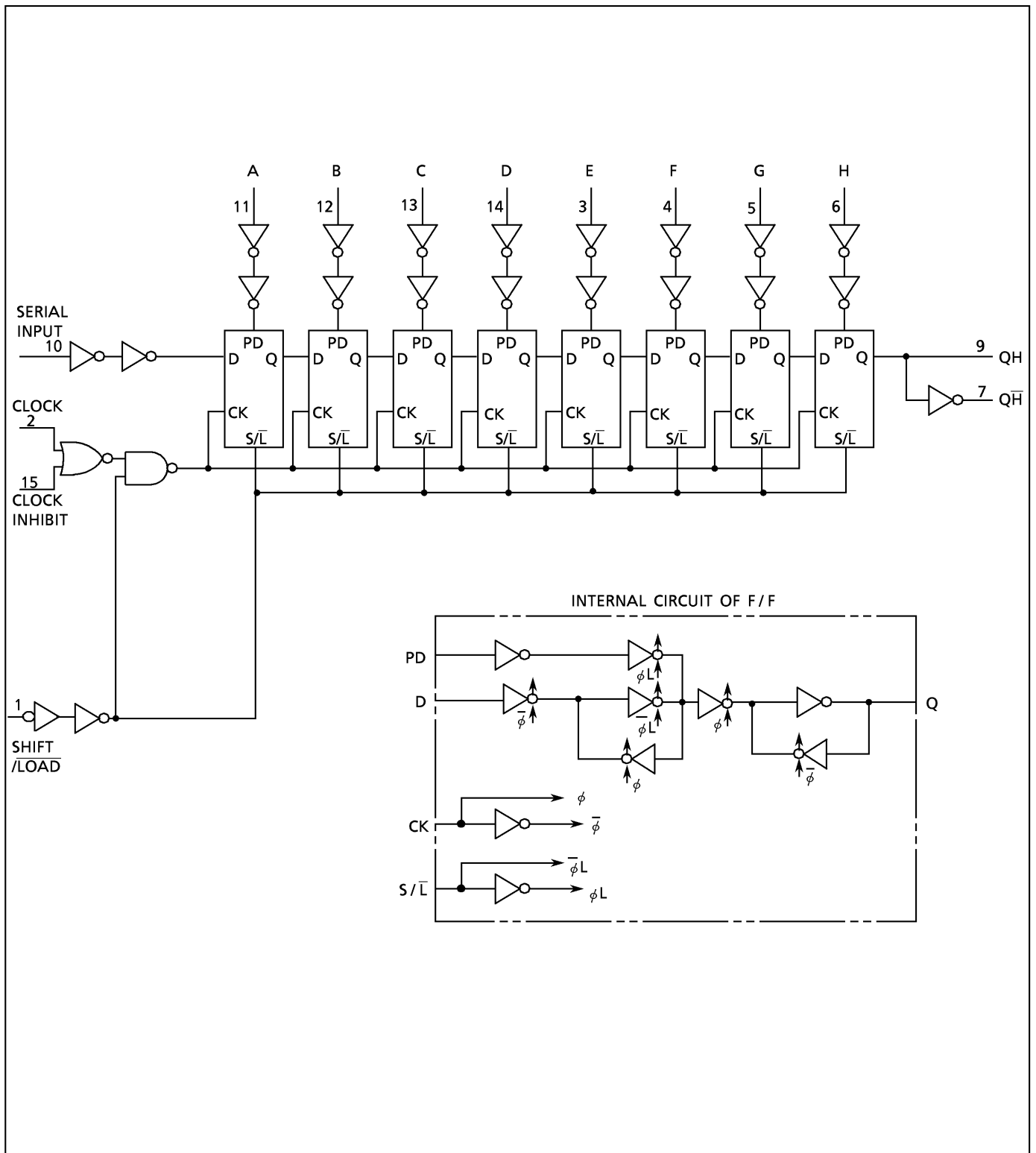
INPUTS					INTERNAL OUTPUTS		OUTPUT	
SHIFT/LOAD	CLOCK INH	CLOCK	SERIAL IN	PARALLEL A H	QA	QB	QH	\overline{QH}
L	X	X	X	a h	a	b	h	\overline{h}
H	L		H	X	H	QAn	QGn	\overline{QGn}
H	L		L	X	L	QAn	QGn	\overline{QGn}
H		L	H	X	H	QAn	QGn	\overline{QGn}
H		L	L	X	L	QAn	QGn	\overline{QGn}
H	X	H	X	X	NO CHANGE			
H	H	X	X	X	NO CHANGE			

X : Don't Care
 a h : The level of steady state input voltage at inputs A through H respectively
 QAn~QGn : The level of QA~QG, respectively, before the most recent positive transition of the CK.

TIMING CHART



SYSTEM DIAGRAM



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V_{CC}	-0.5~7	V
DC Input Voltage	V_{IN}	-0.5~ $V_{CC} + 0.5$	V
DC Output Voltage	V_{OUT}	-0.5~ $V_{CC} + 0.5$	V
Input Diode Current	I_{IK}	±20	mA
Output Diode Current	I_{OK}	±20	mA
DC Output Current	I_{OUT}	±25	mA
DC V_{CC} / Ground Current	I_{CC}	±50	mA
Power Dissipation	P_D	500 (DIP)* / 180 (SOP)	mW
Storage Temperature	T_{stg}	-65~150	°C

*500mW in the range of $T_a = -40^{\circ}\text{C} \sim 65^{\circ}\text{C}$. From $T_a = 65^{\circ}\text{C}$ to 85°C a derating factor of $-10\text{mW}/^{\circ}\text{C}$ shall be applied until 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V_{CC}	2~6	V
Input Voltage	V_{IN}	0~ V_{CC}	V
Output Voltage	V_{OUT}	0~ V_{CC}	V
Operating Temperature	T_{opr}	-40~85	°C
Input Rise and Fall Time	t_r, t_f	0~1000 ($V_{CC} = 2.0\text{V}$) 0~500 ($V_{CC} = 4.5\text{V}$) 0~400 ($V_{CC} = 6.0\text{V}$)	ns

DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	TEST CONDITION	V_{CC} (V)	$T_a = 25^{\circ}\text{C}$			$T_a = -40 \sim 85^{\circ}\text{C}$		UNIT	
				MIN.	TYP.	MAX.	MIN.	MAX.		
High - Level Input Voltage	V_{IH}		2.0	1.50	—	—	1.50	—	V	
			4.5	3.15	—	—	3.15	—		
			6.0	4.20	—	—	4.20	—		
Low - Level Input Voltage	V_{IL}		2.0	—	—	0.50	—	0.50	V	
			4.5	—	—	1.35	—	1.35		
			6.0	—	—	1.80	—	1.80		
High - Level Output Voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -20\mu\text{A}$	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
			$I_{OH} = -4\text{ mA}$ $I_{OH} = -5.2\text{ mA}$	4.5	4.18	4.31	—	4.13	—	
				6.0	5.68	5.80	—	5.63	—	
Low - Level Output Voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 20\mu\text{A}$	2.0	—	0.0	0.1	—	0.1	V
				4.5	—	0.0	0.1	—	0.1	
			$I_{OL} = 4\text{ mA}$ $I_{OL} = 5.2\text{ mA}$	4.5	—	0.17	0.26	—	0.33	
				6.0	—	0.18	0.26	—	0.33	
Input Leakage Current	I_{IN}	$V_{IN} = V_{CC}$ or GND	6.0	—	—	±0.1	—	±1.0	μA	
Quiescent Supply Current	I_{CC}	$V_{IN} = V_{CC}$ or GND	6.0	—	—	4.0	—	40.0		

TIMING REQUIREMENTS OPERATING CONDITIONS (Input $t_r = t_f = 6\text{ns}$)

PARAMETER	SYMBOL	TEST CONDITION	Ta = 25°C			Ta = -40~85°C	UNIT
			V _{CC} (V)	TYP.	LIMIT	LIMIT	
Minimum Pulse Width (CK, CK INH)	$t_{W(H)}$ $t_{W(L)}$		2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Pulse Width (S/ \bar{L})	$t_{W(L)}$		2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Set-up Time (PI-S/ \bar{L})	t_s		2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Set-up Time (SI-CK, CK INH)	t_s		2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Set-up Time (S/ \bar{L} -CK, CK INH)	t_s		2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Minimum Hold Time (PI-S/ \bar{L})	t_h		2.0	—	0	0	
			4.5	—	0	0	
			6.0	—	0	0	
Minimum Hold Time (SI-CK, CK INH)	t_h		2.0	—	0	0	
			4.5	—	0	0	
			6.0	—	0	0	
Minimum Hold Time (S/ \bar{L} -CK, CK INH)	t_h		2.0	—	0	0	
			4.5	—	0	0	
			6.0	—	0	0	
Minimum Removal Time (CK INH-CK) (CK-CK INH)	t_{rem}		2.0	—	75	95	
			4.5	—	15	19	
			6.0	—	13	16	
Clock Frequency	f		2.0	—	7	6	MHz
			4.5	—	30	24	
			6.0	—	41	28	

AC ELECTRICAL CHARACTERISTICS (C_L = 15pF, V_{CC} = 5V, Ta = 25°C, Input $t_r = t_f = 6\text{ns}$)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Transition Time	t_{TLH}		—	4	8	ns
	t_{THL}					
Propagation Delay Time (CK, CK INH-QH, $\bar{Q}H$)	t_{pLH}		—	15	25	
	t_{pHL}					
Propagation Delay Time (S/ \bar{L} -QH, $\bar{Q}H$)	t_{pLH}		—	15	25	
	t_{pHL}					
Propagation Delay Time (H-QH, $\bar{Q}H$)	t_{pLH}		—	14	26	
	t_{pHL}					
Maximum Clock Frequency	f_{MAX}		35	56	—	MHz

AC ELECTRICAL CHARACTERISTICS ($C_L = 50\text{pF}$, Input $t_r = t_f = 6\text{ns}$)

PARAMETER	SYMBOL	TEST CONDITION	Ta = 25°C						Ta = -40~85°C		UNIT
			V _{CC} (V)	MIN.	TYP.	MAX.	MIN.	MAX.			
Output Transition Time	t_{TLH} t_{THL}		2.0	—	25	75	—	95	ns		
			4.5	—	8	15	—	19			
			6.0	—	7	13	—	16			
Propagation Delay Time (CK, CK INH—QH, $\overline{\text{QH}}$)	t_{pLH} t_{pHL}		2.0	—	55	150	—	190	ns		
			4.5	—	18	30	—	38			
			6.0	—	15	26	—	33			
Propagation Delay Time (S/L—QH, $\overline{\text{QH}}$)	t_{pLH} t_{pHL}		2.0	—	60	165	—	205	ns		
			4.5	—	19	33	—	41			
			6.0	—	16	28	—	35			
Propagation Delay Time (H—QH, $\overline{\text{QH}}$)	t_{pHL}		2.0	—	52	135	—	170	ns		
			4.5	—	17	27	—	34			
			6.0	—	14	23	—	29			
Maximum Clock Frequency Frequency	f_{MAX}		2.0	7	14	—	6	—	MHz		
			4.5	30	46	—	24	—			
			6.0	41	65	—	28	—			
Input Capacitance	C_{IN}		—	5	10	—	10	pF			
Power Dissipation Capacitance	$C_{PD}(1)$		—	55	—	—	—				

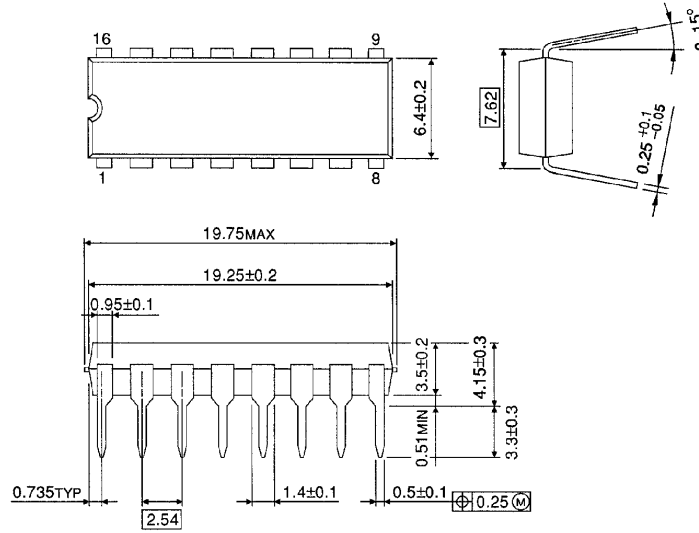
Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

DIP 16PIN PACKAGE DIMENSIONS (DIP16-P-300-2.54A)

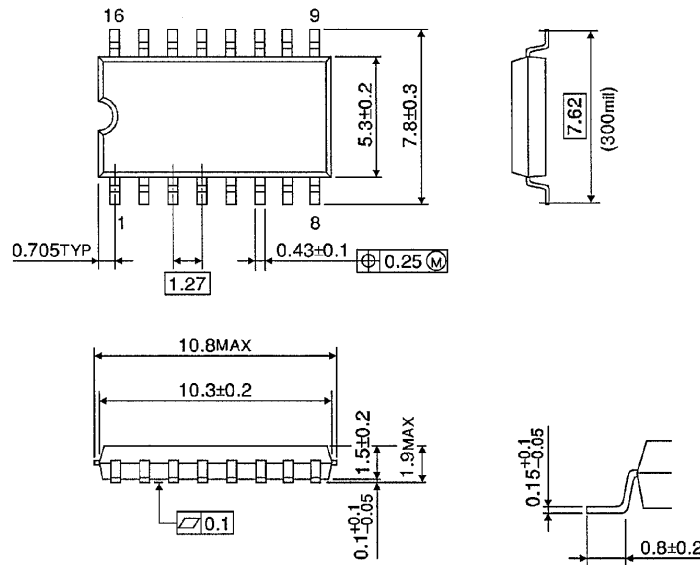
Unit in mm



Weight : 1.00g (Typ.)

SOP 16PIN (200mil BODY) PACKAGE DIMENSIONS (SOP16-P-300-1.27)

Unit in mm

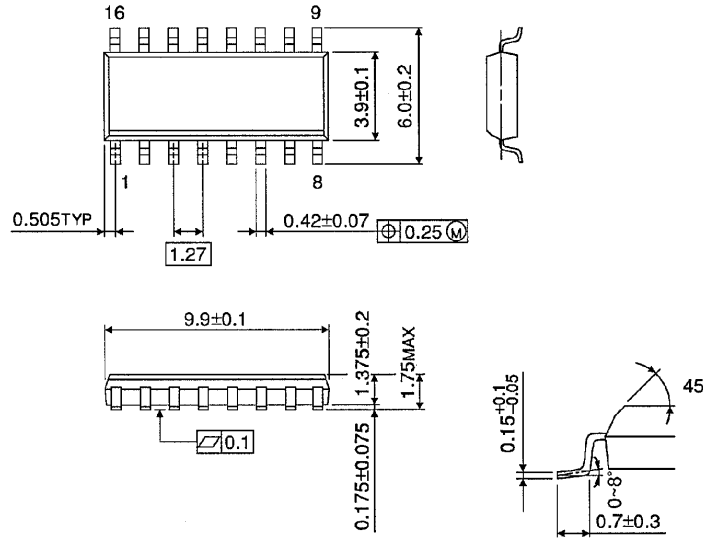


Weight : 0.18g (Typ.)

SOP 16PIN (150mil BODY) PACKAGE DIMENSIONS (SOL16-P-150 -1.27)

Unit in mm

(Note) This package is not available in Japan.



Weight : 0.13g (Typ.)

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